

Enabling the Best Im/W in Mid Power Range

Mid-Power LED - 5630 Series

SAW8Q24D (Cool, Neutral, Warm)







Product Brief

Description

- This White Colored surface-mount LED comes in standard package dimension. Package Size: 5.6x3.0x0.65mm
- It has a substrate made up of a molded plastic reflector sitting on top of a lead frame.
- The die is attached within the reflector cavity and the cavity is encapsulated by silicone.
- The package design coupled with careful selection of component materials allow these products to perform with high reliability.

Features and Benefits

- Market Standard 5630 Package Size
- High Color Quality, CRI Min. 80
- ANSI & MacAdam 3 Step compliant
- RoHS compliant

Key Applications

- Interior lighting
- General lighting
- Indoor and outdoor displays
- Architectural / Decorative lighting

Table 1. Product Selection Table

David Marrish an		ССТ		
Part Number	Color	Min.	Тур.	Max.
SAW8Q24D	Cool White	4,700K	5,600K	7,000K
SAW8Q24D	Neutral White	3,700K	4,200K	4,700K
SAW8Q24D	Warm White	2,600K	3,000K	3,700K



Table of Contents

Inde	ex .	
•	Product Brief	1
•	Table of Contents	2
•	Performance Characteristics	3
•	Characteristics Graph	5
•	Color Bin Structure	11
•	Mechanical Dimensions	21
•	Recommended Solder Pad	22
•	Reflow Soldering Characteristics	23
•	Emitter Tape & Reel Packaging	24
•	Product Nomenclature	26
•	Handling of Silicone Resin for LEDs	27
•	Precaution For Use	28
•	Company Information	31

Performance Characteristics

Table 2. Electro Optical Characteristics, I_F =32mA, T_i=25°C, RH30%

5.4	CCT (K) ^[1]		Luminous	Intensity ^[2]	Lumino	ıs Flux ^[3]	CRI
Part Number	001 (11)	RANK	I _V (cd)	Φν	(lm)	Ra
	Тур.] [Min	Max	Min	Max	Min.
	6500	T5	10.5	11.0	33.4	35.0	80
		U0	11.0	11.7	35.0	37.2	80
	5600	T5	10.5	11.0	33.4	35.0	80
	5600	U0	11.0	11.7	35.0	37.2	80
		T5	10.5	11.0	33.4	35.0	80
	5000	U0	11.0	11.7	35.0	37.2	80
		U7	11.7	12.5	37.2	39.8	80
		T5	10.5	11.0	33.1	34.7	80
	4500	U0	11.0	11.7	34.7	36.9	80
		U7	11.7	12.5	36.9	39.4	80
SAW8Q24D		T5	10.5	11.0	33.1	34.7	80
SAW6Q24D	4000	U0	11.0	11.7	34.7	36.9	80
		U7	11.7	12.5	36.9	39.4	80
		T0	10.0	10.2	31.2	31.8	80
	3500	T5	10.5	11.0	32.7	34.3	80
		U0	11.0	11.7	34.3	36.6	80
		T0	10.0	10.2	31.2	31.8	80
	3000	T5	10.5	11.0	32.7	34.3	80
		U0	11.0	11.7	34.3	36.6	80
		T0	10.0	10.2	31.2	31.8	80
	2700	T5	10.5	11.0	32.7	34.3	80
		U0	11.0	11.7	34.3	36.6	80

Notes:

- (1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.
- (2) Seoul Semiconductor maintains a tolerance of $\pm 7\%$ on Intensity and power measurements. The luminous intensity IV was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.
- (3) The lumen table is only for reference.
- (4) Solid angle 0.01sr (reference)

Performance Characteristics

Table 3. Characteristics, I_F=32mA, T_i= 25°C, RH30%

Doromotor	Cumbal		Value		Unit
Parameter	Symbol	Min.	Тур.	Max.	Onit
Forward Current	l _F	-	32	100	mA
Luminous Intensity ^[1] (5,000K) ^[2]	l _v	10.5	11.3	-	cd
CRI ^[3]	R _a	80	83	90	
Viewing Angle	2Θ _{1/2}	-	120	-	Deg.
Thermal resistance (J to S) [4]	$R\theta_{J-S}$	-	7	-	°C/W
ESD Sensitivity(HBM)	-		Class 3A JES	D22-A114-E	

Table 4. Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Forward Current	I _F	100	mA
Froward Voltage	V_{F}	6.0	V
Power Dissipation	P_{D}	0.6	W
Junction Temperature	T _j	125	°C
Operating Temperature	T_{opr}	-40 ~ + 85	°C
Storage Temperature	T _{stg}	-40 ~ + 100	°C

Notes:

- (1) Seoul Semiconductor maintains a tolerance of $\pm 7\%$ on Intensity and power measurements.
- $\hbox{(2) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.}\\$

Color coordinate: ±0.005, CCT ±5% tolerance.

- (3) Tolerance is ±2.0 on CRI measurements.
- (4) Thermal resistance is junction to Solder.
- (5) I_{FP} conditions with pulse width \leq 10ms and duty cycle \leq 10%
- · Calculated performance values are for reference only.
- · All measurements were made under the standardized environment of Seoul Semiconductor.

Fig 1. Color Spectrum, $T_j = 25^{\circ}C$, $I_F=32mA$

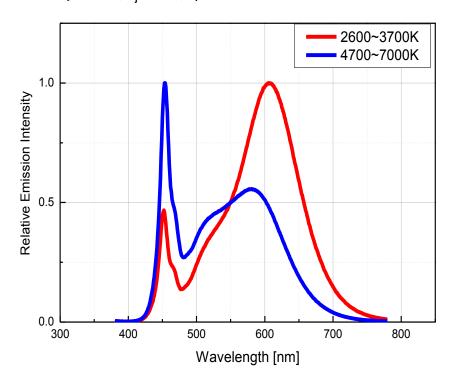


Fig 2. Radiant Pattern, T_i = 25°C, I_F=32mA

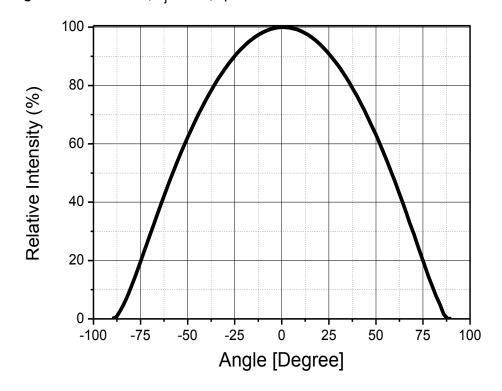


Fig 3. Forward Voltage vs. Forward Current, $T_j = 25^{\circ}C$

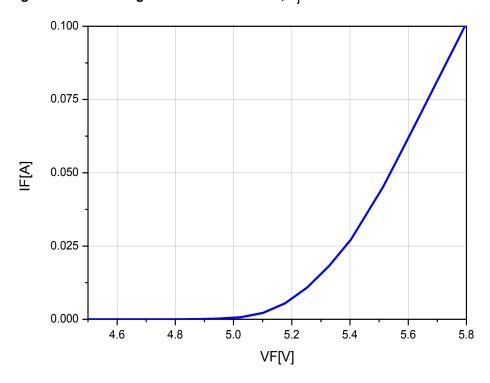


Fig 4. Forward Current vs. Relative Luminous Intensity, $T_i = 25^{\circ}C$

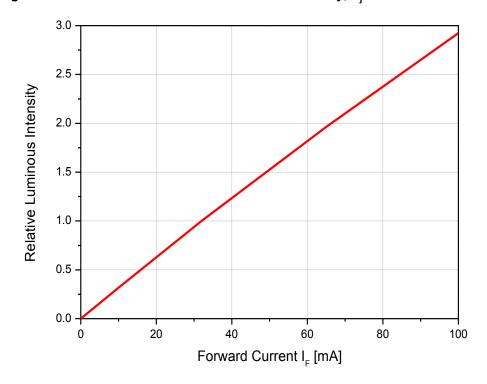
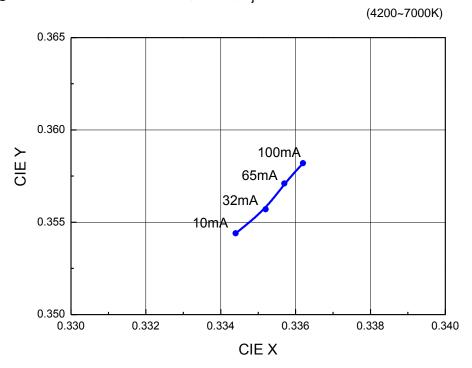


Fig 5. Forward Current vs. CIE X,Y Shift, T_i = 25°C



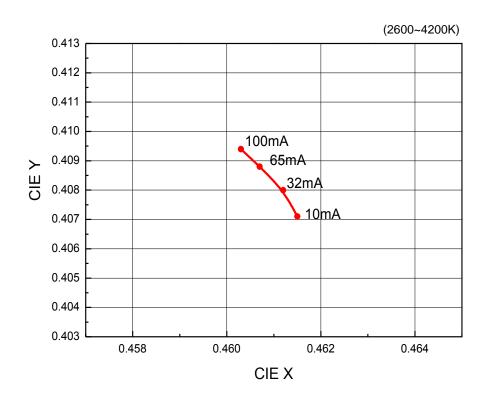


Fig 6. Junction Temperature vs. Relative Luminous Intensity, I_F=32mA

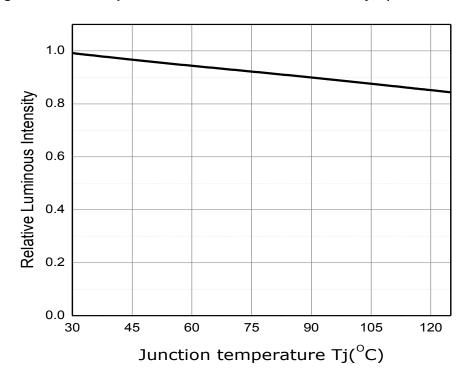


Fig 7. Junction Temperature vs. Relative Forward Voltage, I_F=32mA

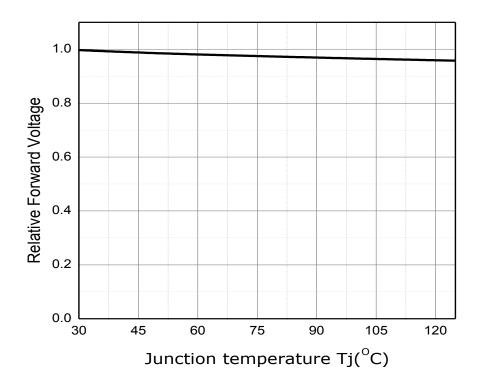
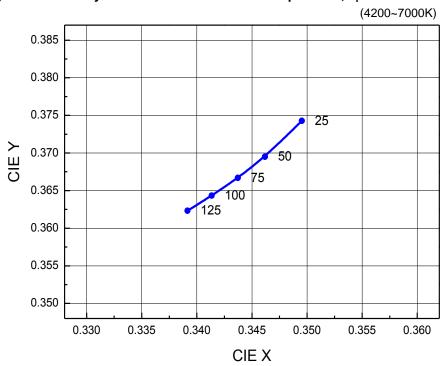


Fig 8. Chromaticity Coordinate vs. Junction Temperature, I_F=32mA



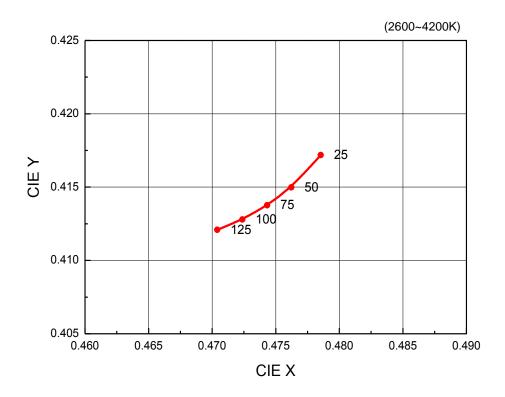
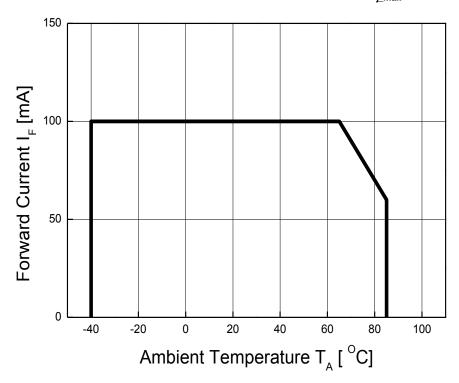


Fig 9. Ambient Temperature vs. Maximum Forward Current, T_{j_max} = 125 $^{\circ}$ C



Performance Characteristics

Table 5. Bin Code description, T_i=25 ℃, I_F=32mA

Part Number	Luminous Intensity (cd)			Color	Туріса	al Forward V (V)	'oltage
Fart Number	Bin Code	Min.	Max.	Chromaticity Coordinate	Bin Code	Min.	Max.
	T0	10.0	10.5		Z54	5.4	5.6
SAW8Q24D	T5	10.5	11.0	Refer to	Z56	5.6	5.8
SAW6Q24D	U0	11.0	11.7	Page. 12	Z58	5.8	6.0
	U7	11.7	12.5				

Table 6. Intensity rank distribution

Available ranks

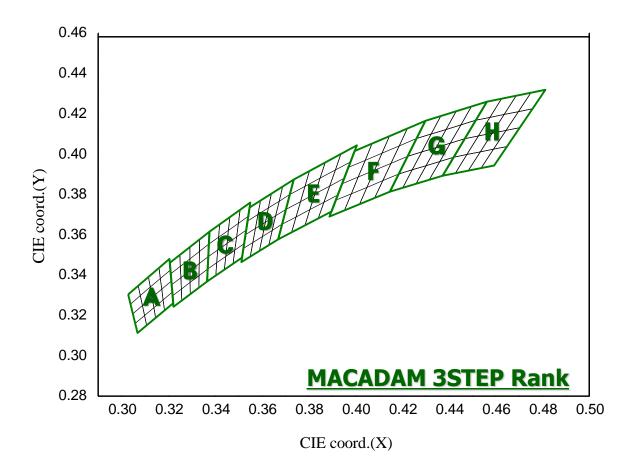
ССТ	CIE		IV R	lank	
6000 ~ 7000K	Α	ТО	T5	U0	U7
5300 – 6000K	В	ТО	T5	U0	U7
4700 ~ 5300K	С	ТО	T5	U0	U7
4200 ~ 4700K	D	ТО	T5	U0	U7
3700 ~ 4200K	E	ТО	T5	U0	U7
3200 ~ 3700K	F	ТО	T5	U0	U7
2900 ~ 3200K	G	T0	T5	U0	U7
2600 ~ 2900K	Н	ТО	T5	U0	U7

*Notes:

- (1) Calculated performance values are for reference only.
- All measurements were made under the standardized environment of Seoul Semiconductor.
 In order to ensure availability, single color rank will not be orderable.

Color Bin Structure

CIE Chromaticity Diagram T_i=25 °C, I_F=32mA

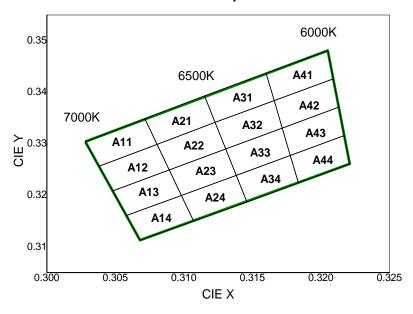


*Notes:

- Energy Star binning applied to all 2600~7000K.
- Measurement Uncertainty of the Color Coordinates : $\pm~0.005$

Color Bin Structure

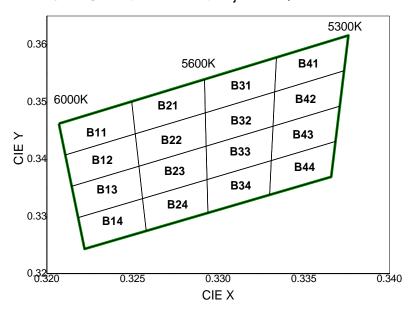
CIE Chromaticity Diagram (Cool white), $T_i=25\,^{\circ}C$, $I_F=32mA$



A	11	A	21	A3	31	A	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3028	0.3304	0.3072	0.3349	0.3115	0.3393	0.3160	0.3437
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
0.3072	0.3349	0.3115	0.3393	0.3160	0.3437	0.3205	0.3481
A	12	A:	22	A3	32	A	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3048	0.3209	0.3089	0.3249	0.3131	0.3290	0.3172	0.3331
0.3089	0.3249	0.3131	0.3290	0.3172	0.3331	0.3213	0.3371
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
A [,]	13	A	23	A3	33	A	43
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3048			CIE Y 0.3249	CIE X 0.3131	CIE Y 0.3290	CIE X 0.3172	CIE Y 0.3331
	CIE Y	CIE X					
0.3048	CIE Y 0.3209	CIE X 0.3089	0.3249	0.3131	0.3290	0.3172	0.3331
0.3048 0.3058	CIE Y 0.3209 0.3161	CIE X 0.3089 0.3098	0.3249	0.3131 0.3138	0.3290 0.3239	0.3172 0.3178	0.3331 0.3277
0.3048 0.3058 0.3098	CIE Y 0.3209 0.3161 0.3200 0.3249	CIE X 0.3089 0.3098 0.3138 0.3131	0.3249 0.3200 0.3239	0.3131 0.3138 0.3178	0.3290 0.3239 0.3277 0.3331	0.3172 0.3178 0.3217	0.3331 0.3277 0.3316 0.3371
0.3048 0.3058 0.3098 0.3089	CIE Y 0.3209 0.3161 0.3200 0.3249	CIE X 0.3089 0.3098 0.3138 0.3131	0.3249 0.3200 0.3239 0.3290	0.3131 0.3138 0.3178 0.3172	0.3290 0.3239 0.3277 0.3331	0.3172 0.3178 0.3217 0.3213	0.3331 0.3277 0.3316 0.3371
0.3048 0.3058 0.3098 0.3089	CIE Y 0.3209 0.3161 0.3200 0.3249	CIE X 0.3089 0.3098 0.3138 0.3131	0.3249 0.3200 0.3239 0.3290	0.3131 0.3138 0.3178 0.3172	0.3290 0.3239 0.3277 0.3331	0.3172 0.3178 0.3217 0.3213	0.3331 0.3277 0.3316 0.3371
0.3048 0.3058 0.3098 0.3089 A	CIE Y 0.3209 0.3161 0.3200 0.3249 14 CIE Y	CIE X 0.3089 0.3098 0.3138 0.3131 A' CIE X	0.3249 0.3200 0.3239 0.3290 24 CIE Y	0.3131 0.3138 0.3178 0.3172 A3	0.3290 0.3239 0.3277 0.3331	0.3172 0.3178 0.3217 0.3213 ACCIE X	0.3331 0.3277 0.3316 0.3371 44 CIE Y
0.3048 0.3058 0.3098 0.3089 A' CIE X 0.3058	CIE Y 0.3209 0.3161 0.3200 0.3249 14 CIE Y 0.3161	CIE X 0.3089 0.3098 0.3138 0.3131 ACCIE X 0.3098	0.3249 0.3200 0.3239 0.3290 24 CIE Y 0.3200	0.3131 0.3138 0.3178 0.3172 A3 CIE X 0.3138	0.3290 0.3239 0.3277 0.3331 34 CIE Y 0.3239	0.3172 0.3178 0.3217 0.3213 ACCIE X 0.3178	0.3331 0.3277 0.3316 0.3371 44 CIE Y 0.3277

Color Bin Structure

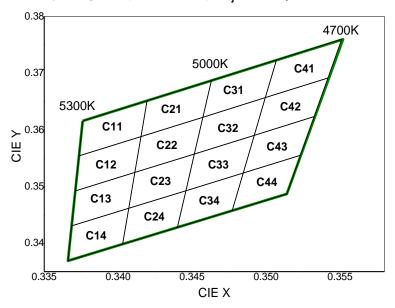
CIE Chromaticity Diagram (Cool white), $T_i=25\,^{\circ}C$, $I_F=32mA$



B'	11	B	21	B3	31	В	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3207	0.3462	0.3250	0.3501	0.3292	0.3539	0.3334	0.3578
0.3211	0.3407	0.3252	0.3444	0.3293	0.3481	0.3333	0.3518
0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	0.3374	0.3554
0.3250	0.3501	0.3292	0.3539	0.3334	0.3578	0.3376	0.3616
B [']	12	B	22	B3	32	В	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3211	0.3407	0.3252	0.3444	0.3293	0.3481	0.3333	0.3518
0.3215	0.3353	0.3254	0.3388	0.3293	0.3423	0.3332	0.3458
0.3254	0.3388	0.3293	0.3423	0.3332	0.3458	0.3371	0.3493
0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	0.3374	0.3554
-					-		
B [*]	13	B	23	B3	33	B ₁	43
CIE X	CIE Y	CIE X	23 CIE Y	CIE X	CIE Y	CIE X	43 CIE Y
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3215	CIE Y 0.3353	CIE X 0.3254	CIE Y 0.3388	CIE X 0.3293	CIE Y 0.3423	CIE X 0.3332	CIE Y 0.3458
CIE X 0.3215 0.3218	CIE Y 0.3353 0.3298	CIE X 0.3254 0.3256	CIE Y 0.3388 0.3331	CIE X 0.3293 0.3294	CIE Y 0.3423 0.3364	CIE X 0.3332 0.3331	CIE Y 0.3458 0.3398
CIE X 0.3215 0.3218 0.3256	CIE Y 0.3353 0.3298 0.3331 0.3388	CIE X 0.3254 0.3256 0.3294 0.3293	CIE Y 0.3388 0.3331 0.3364	CIE X 0.3293 0.3294 0.3331	CIE Y 0.3423 0.3364 0.3398 0.3458	CIE X 0.3332 0.3331 0.3369 0.3371	CIE Y 0.3458 0.3398 0.3431
CIE X 0.3215 0.3218 0.3256 0.3254	CIE Y 0.3353 0.3298 0.3331 0.3388	CIE X 0.3254 0.3256 0.3294 0.3293	CIE Y 0.3388 0.3331 0.3364 0.3423	CIE X 0.3293 0.3294 0.3331 0.3332	CIE Y 0.3423 0.3364 0.3398 0.3458	CIE X 0.3332 0.3331 0.3369 0.3371	CIE Y 0.3458 0.3398 0.3431 0.3493
CIE X 0.3215 0.3218 0.3256 0.3254	CIE Y 0.3353 0.3298 0.3331 0.3388	CIE X 0.3254 0.3256 0.3294 0.3293 B:	CIE Y 0.3388 0.3331 0.3364 0.3423	CIE X 0.3293 0.3294 0.3331 0.3332	CIE Y 0.3423 0.3364 0.3398 0.3458	CIE X 0.3332 0.3331 0.3369 0.3371	CIE Y 0.3458 0.3398 0.3431 0.3493
CIE X 0.3215 0.3218 0.3256 0.3254 B' CIE X	CIE Y 0.3353 0.3298 0.3331 0.3388 14 CIE Y	CIE X 0.3254 0.3256 0.3294 0.3293 B; CIE X	CIE Y 0.3388 0.3331 0.3364 0.3423 24 CIE Y	CIE X 0.3293 0.3294 0.3331 0.3332 B3 CIE X	CIE Y 0.3423 0.3364 0.3398 0.3458 4 CIE Y	CIE X 0.3332 0.3331 0.3369 0.3371 BCIE X	CIE Y 0.3458 0.3398 0.3431 0.3493 44 CIE Y
CIE X 0.3215 0.3218 0.3256 0.3254 B ² CIE X 0.3218	CIE Y 0.3353 0.3298 0.3331 0.3388 14 CIE Y 0.3298	CIE X 0.3254 0.3256 0.3294 0.3293 B: CIE X 0.3256	CIE Y 0.3388 0.3331 0.3364 0.3423 24 CIE Y 0.3331	CIE X 0.3293 0.3294 0.3331 0.3332 B3 CIE X 0.3294	CIE Y 0.3423 0.3364 0.3398 0.3458 34 CIE Y 0.3364	CIE X 0.3332 0.3331 0.3369 0.3371 Br CIE X 0.3331	CIE Y 0.3458 0.3398 0.3431 0.3493 44 CIE Y 0.3398

Color Bin Structure

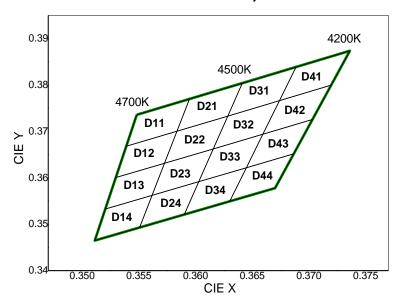
CIE Chromaticity Diagram (Cool white), T_j =25 $^{\circ}$ C, I_F =32mA



C1	11	C	21	C3	31	C.	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3376	0.3616	0.3420	0.3652	0.3463	0.3687	0.3507	0.3724
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
0.3420	0.3652	0.3463	0.3687	0.3507	0.3724	0.3551	0.3760
C	12	C	22	C3	32	C.	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3371	0.3493	0.3411	0.3525	0.3452	0.3558	0.3492	0.3591
0.3411	0.3525	0.3452	0.3558	0.3492	0.3591	0.3533	0.3624
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
C1	13	C	23	C3	33	C	43
CIE X	13 CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
· ·							
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3371	CIE Y 0.3493	CIE X 0.3411	CIE Y 0.3525	CIE X 0.3452	CIE Y 0.3558	CIE X 0.3492	CIE Y 0.3591
CIE X 0.3371 0.3369	CIE Y 0.3493 0.3431	CIE X 0.3411 0.3407	CIE Y 0.3525 0.3462	CIE X 0.3452 0.3446	CIE Y 0.3558 0.3493	CIE X 0.3492 0.3485	CIE Y 0.3591 0.3524
CIE X 0.3371 0.3369 0.3407	CIE Y 0.3493 0.3431 0.3462 0.3525	CIE X 0.3411 0.3407 0.3446 0.3452	CIE Y 0.3525 0.3462 0.3493	CIE X 0.3452 0.3446 0.3485	CIE Y 0.3558 0.3493 0.3524 0.3591	CIE X 0.3492 0.3485 0.3523 0.3533	CIE Y 0.3591 0.3524 0.3555
CIE X 0.3371 0.3369 0.3407 0.3411	CIE Y 0.3493 0.3431 0.3462 0.3525	CIE X 0.3411 0.3407 0.3446 0.3452	CIE Y 0.3525 0.3462 0.3493 0.3558	CIE X 0.3452 0.3446 0.3485 0.3492	CIE Y 0.3558 0.3493 0.3524 0.3591	CIE X 0.3492 0.3485 0.3523 0.3533	CIE Y 0.3591 0.3524 0.3555 0.3624
CIE X 0.3371 0.3369 0.3407 0.3411	CIE Y 0.3493 0.3431 0.3462 0.3525	CIE X 0.3411 0.3407 0.3446 0.3452	CIE Y 0.3525 0.3462 0.3493 0.3558	CIE X 0.3452 0.3446 0.3485 0.3492	CIE Y 0.3558 0.3493 0.3524 0.3591	CIE X 0.3492 0.3485 0.3523 0.3533	CIE Y 0.3591 0.3524 0.3555 0.3624
CIE X 0.3371 0.3369 0.3407 0.3411 C' CIE X	CIE Y 0.3493 0.3431 0.3462 0.3525 14 CIE Y	CIE X 0.3411 0.3407 0.3446 0.3452 CIE X	CIE Y 0.3525 0.3462 0.3493 0.3558 24 CIE Y	CIE X 0.3452 0.3446 0.3485 0.3492 CIE X	CIE Y 0.3558 0.3493 0.3524 0.3591 34 CIE Y	CIE X 0.3492 0.3485 0.3523 0.3533 CIE X	CIE Y 0.3591 0.3524 0.3555 0.3624 44 CIE Y
CIE X 0.3371 0.3369 0.3407 0.3411 C1 CIE X 0.3369	CIE Y 0.3493 0.3431 0.3462 0.3525 14 CIE Y 0.3431	CIE X 0.3411 0.3407 0.3446 0.3452 CIE X 0.3407	CIE Y 0.3525 0.3462 0.3493 0.3558 24 CIE Y 0.3462	CIE X 0.3452 0.3446 0.3485 0.3492 CIE X 0.3446	CIE Y 0.3558 0.3493 0.3524 0.3591 34 CIE Y 0.3493	CIE X 0.3492 0.3485 0.3523 0.3533 CIE X 0.3485	CIE Y 0.3591 0.3524 0.3555 0.3624 44 CIE Y 0.3524

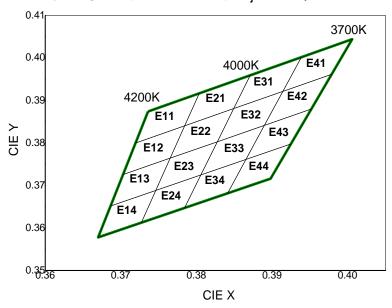
Color Bin Structure

CIE Chromaticity Diagram (Neutral white), $T_i=25\,^{\circ}$, $I_F=32mA$



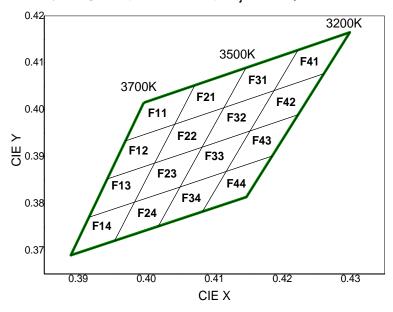
D.	11	D	21	D3	31	D.	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3548	0.3736	0.3595	0.3770	0.3641	0.3804	0.3689	0.3839
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800
0.3595	0.3770	0.3641	0.3804	0.3689	0.3839	0.3736	0.3874
D.	12	D:	22 -	D3	32	D.	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767
0.3530	0.3601	0.3573	0.3632	0.3616	0.3663	0.3659	0.3694
0.3573	0.3632	0.3616	0.3663	0.3659	0.3694	0.3703	0.3726
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800
D.	13	D	23	D3	33	D	43
CIE X	13 CIE Y	CIE X	23 CIE Y	CIE X	CIE Y	CIE X	43 CIE Y
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3530	CIE Y 0.3601	CIE X 0.3573	CIE Y 0.3632	CIE X 0.3616	CIE Y 0.3663	CIE X 0.3659	CIE Y 0.3694
CIE X 0.3530 0.3520	CIE Y 0.3601 0.3533	CIE X 0.3573 0.3562	CIE Y 0.3632 0.3562	CIE X 0.3616 0.3603	CIE Y 0.3663 0.3592	CIE X 0.3659 0.3645	CIE Y 0.3694 0.3622
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592	CIE X 0.3616 0.3603 0.3645	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592 0.3663	CIE X 0.3616 0.3603 0.3645 0.3659	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652 0.3726
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592 0.3663	CIE X 0.3616 0.3603 0.3645 0.3659	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652 0.3726
CIE X 0.3530 0.3520 0.3562 0.3573 D: CIE X	CIE Y 0.3601 0.3533 0.3562 0.3632 14 CIE Y	CIE X 0.3573 0.3562 0.3603 0.3616 D: CIE X	CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y	CIE X 0.3616 0.3603 0.3645 0.3659 D3	CIE Y 0.3663 0.3592 0.3622 0.3694 34 CIE Y	CIE X 0.3659 0.3645 0.3687 0.3703 D.CIE X	CIE Y 0.3694 0.3622 0.3652 0.3726 44 CIE Y
CIE X 0.3530 0.3520 0.3562 0.3573 D: CIE X 0.3520	CIE Y 0.3601 0.3533 0.3562 0.3632 14 CIE Y 0.3533	CIE X 0.3573 0.3562 0.3603 0.3616 D: CIE X 0.3562	CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y 0.3562	OIE X 0.3616 0.3603 0.3645 0.3659 D3 CIE X 0.3603	CIE Y 0.3663 0.3592 0.3622 0.3694 34 CIE Y 0.3592	CIE X 0.3659 0.3645 0.3687 0.3703 D CIE X 0.3645	CIE Y 0.3694 0.3622 0.3652 0.3726 44 CIE Y 0.3622

Color Bin Structure



E′	11	E	21	E:	31	E-	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3736	0.3874	0.3804	0.3917	0.3871	0.3959	0.3939	0.4002
0.3720	0.3800	0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3784	0.3841	0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
0.3804	0.3917	0.3871	0.3959	0.3939	0.4002	0.4006	0.4044
E ²	12	E:	22	E3	32	E.	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3720	0.3800	0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3703	0.3726	0.3765	0.3765	0.3828	0.3803	0.3890	0.3842
0.3765	0.3765	0.3828	0.3803	0.3890	0.3842	0.3952	0.3880
0.3784	0.3841	0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
E′	13	E	23	E3	33	E,	43
CIE X	13 CIE Y	CIE X	23 CIE Y	CIE X	CIE Y	CIE X	43 CIE Y
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3703	CIE Y 0.3726	CIE X 0.3765	CIE Y 0.3765	CIE X 0.3828	CIE Y 0.3803	CIE X 0.3890	CIE Y 0.3842
CIE X 0.3703 0.3687	CIE Y 0.3726 0.3652	CIE X 0.3765 0.3746	CIE Y 0.3765 0.3689	CIE X 0.3828 0.3806	CIE Y 0.3803 0.3725	CIE X 0.3890 0.3865	CIE Y 0.3842 0.3762
CIE X 0.3703 0.3687 0.3746	CIE Y 0.3726 0.3652 0.3689 0.3765	CIE X 0.3765 0.3746 0.3806 0.3828	CIE Y 0.3765 0.3689 0.3725	CIE X 0.3828 0.3806 0.3865	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925 0.3952	CIE Y 0.3842 0.3762 0.3798
CIE X 0.3703 0.3687 0.3746 0.3765	CIE Y 0.3726 0.3652 0.3689 0.3765	CIE X 0.3765 0.3746 0.3806 0.3828	CIE Y 0.3765 0.3689 0.3725 0.3803	CIE X 0.3828 0.3806 0.3865 0.3890	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925 0.3952	CIE Y 0.3842 0.3762 0.3798 0.3880
CIE X 0.3703 0.3687 0.3746 0.3765	CIE Y 0.3726 0.3652 0.3689 0.3765	CIE X 0.3765 0.3746 0.3806 0.3828	CIE Y 0.3765 0.3689 0.3725 0.3803	CIE X 0.3828 0.3806 0.3865 0.3890	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925 0.3952	CIE Y 0.3842 0.3762 0.3798 0.3880
CIE X 0.3703 0.3687 0.3746 0.3765 E	CIE Y 0.3726 0.3652 0.3689 0.3765 14 CIE Y	CIE X 0.3765 0.3746 0.3806 0.3828	CIE Y 0.3765 0.3689 0.3725 0.3803 24 CIE Y	CIE X 0.3828 0.3806 0.3865 0.3890 ESCIE X	CIE Y 0.3803 0.3725 0.3762 0.3842 34 CIE Y	CIE X 0.3890 0.3865 0.3925 0.3952 Exercise X	CIE Y 0.3842 0.3762 0.3798 0.3880 44 CIE Y
CIE X 0.3703 0.3687 0.3746 0.3765 E* CIE X 0.3687	CIE Y 0.3726 0.3652 0.3689 0.3765 14 CIE Y 0.3652	CIE X 0.3765 0.3746 0.3806 0.3828 CIE X 0.3746	CIE Y 0.3765 0.3689 0.3725 0.3803 24 CIE Y 0.3689	CIE X 0.3828 0.3806 0.3865 0.3890 ESCUE X 0.3806	CIE Y 0.3803 0.3725 0.3762 0.3842 34 CIE Y 0.3725	CIE X 0.3890 0.3865 0.3925 0.3952 EACHE X 0.3865	CIE Y 0.3842 0.3762 0.3798 0.3880 44 CIE Y 0.3762

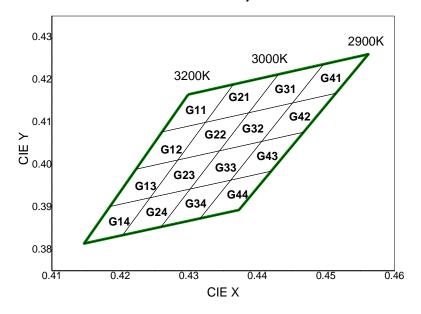
Color Bin Structure



F11		F21		F31		F41		
CIE X	CIE Y							
0.3996	0.4015	0.4071	0.4052	0.4146	0.4089	0.4223	0.4127	
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077	
0.4071	0.4052	0.4146	0.4089	0.4223	0.4127	0.4299	0.4165	
F	12	F:	22	F3	32	F4	42	
CIE X	CIE Y							
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	
0.3943	0.3853	0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	
0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	0.4223	0.3990	
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077	
F1	F13		F23		F33		F43	
CIE X	CIE Y							
0.3943	0.3853	0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	
0.3916	0.3771	0.3983	0.3803	0.4049	0.3836	0.4117	0.3869	
0.3983	0.3803	0.4049	0.3836	0.4117	0.3869	0.4185	0.3902	
0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	0.4223	0.3990	
F14		F24		F34		F44		
CIE X	CIE Y							
0.3916	0.3771	0.3983	0.3803	0.4049	0.3836	0.4117	0.3869	
0.3889	0.3690	0.3953	0.3721	0.4017	0.3751	0.4082	0.3783	
0.3953	0.3721	0.4017	0.3751	0.4082	0.3783	0.4147	0.3814	
0.3983	0.3803	0.4049	0.3836		0.3869	0.4185	0.3902	

Color Bin Structure

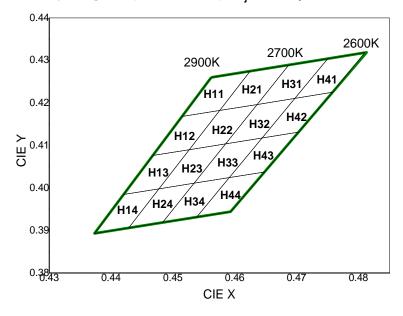
CIE Chromaticity Diagram (Warm white), T_i=25 ℃, I_F=32mA



G11		G21		G31		G41	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4299	0.4165	0.4364	0.4188	0.4430	0.4212	0.4496	0.4236
0.4261	0.4077	0.4324	0.4099	0.4387	0.4122	0.4451	0.4145
0.4324	0.4100	0.4387	0.4122	0.4451	0.4145	0.4514	0.4168
0.4365	0.4189	0.4430	0.4212	0.4496	0.4236	0.4562	0.4260
G12		G22		G32		G42	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4261	0.4077	0.4324	0.4100	0.4387	0.4122	0.4451	0.4145
0.4223	0.3990	0.4284	0.4011	0.4345	0.4033	0.4406	0.4055
0.4284	0.4011	0.4345	0.4033	0.4406	0.4055	0.4468	0.4077
0.4324	0.4100	0.4387	0.4122	0.4451	0.4145	0.4515	0.4168
G13							
G.	13	G	23	G	33	G.	43
G ^z CIE X	13 CIE Y	G. CIE X	CIE Y	G: CIE X	CIE Y	G/ CIE X	43 CIE Y
-							
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.4223	CIE Y 0.3990	CIE X 0.4284	CIE Y 0.4011	CIE X 0.4345	CIE Y 0.4033	CIE X 0.4406	CIE Y 0.4055
CIE X 0.4223 0.4185	CIE Y 0.3990 0.3902	CIE X 0.4284 0.4243	CIE Y 0.4011 0.3922	CIE X 0.4345 0.4302	CIE Y 0.4033 0.3943	CIE X 0.4406 0.4361	CIE Y 0.4055 0.3964
CIE X 0.4223 0.4185 0.4243	CIE Y 0.3990 0.3902 0.3922 0.4011	CIE X 0.4284 0.4243 0.4302 0.4345	CIE Y 0.4011 0.3922 0.3943	CIE X 0.4345 0.4302 0.4361	CIE Y 0.4033 0.3943 0.3964 0.4055	O.4406 0.4361 0.4420	CIE Y 0.4055 0.3964 0.3985 0.4077
CIE X 0.4223 0.4185 0.4243 0.4284	CIE Y 0.3990 0.3902 0.3922 0.4011	CIE X 0.4284 0.4243 0.4302 0.4345	CIE Y 0.4011 0.3922 0.3943 0.4033	CIE X 0.4345 0.4302 0.4361 0.4406	CIE Y 0.4033 0.3943 0.3964 0.4055	CIE X 0.4406 0.4361 0.4420 0.4468	CIE Y 0.4055 0.3964 0.3985 0.4077
CIE X 0.4223 0.4185 0.4243 0.4284	CIE Y 0.3990 0.3902 0.3922 0.4011	CIE X 0.4284 0.4243 0.4302 0.4345	CIE Y 0.4011 0.3922 0.3943 0.4033	CIE X 0.4345 0.4302 0.4361 0.4406	CIE Y 0.4033 0.3943 0.3964 0.4055	CIE X 0.4406 0.4361 0.4420 0.4468	CIE Y 0.4055 0.3964 0.3985 0.4077
CIE X 0.4223 0.4185 0.4243 0.4284 G' CIE X	CIE Y 0.3990 0.3902 0.3922 0.4011 14 CIE Y	CIE X 0.4284 0.4243 0.4302 0.4345 G CIE X	CIE Y 0.4011 0.3922 0.3943 0.4033 24 CIE Y	CIE X 0.4345 0.4302 0.4361 0.4406 GS	CIE Y 0.4033 0.3943 0.3964 0.4055	CIE X 0.4406 0.4361 0.4420 0.4468 GCIE X	CIE Y 0.4055 0.3964 0.3985 0.4077 44 CIE Y
CIE X 0.4223 0.4185 0.4243 0.4284 G* CIE X 0.4243	CIE Y 0.3990 0.3902 0.3922 0.4011 14 CIE Y 0.3922	CIE X 0.4284 0.4243 0.4302 0.4345 G CIE X 0.4302	CIE Y 0.4011 0.3922 0.3943 0.4033 24 CIE Y 0.3943	CIE X 0.4345 0.4302 0.4361 0.4406 CIE X 0.4302	CIE Y 0.4033 0.3943 0.3964 0.4055 64 CIE Y 0.3943	CIE X 0.4406 0.4361 0.4420 0.4468 GCIE X 0.4361	CIE Y 0.4055 0.3964 0.3985 0.4077 44 CIE Y 0.3964

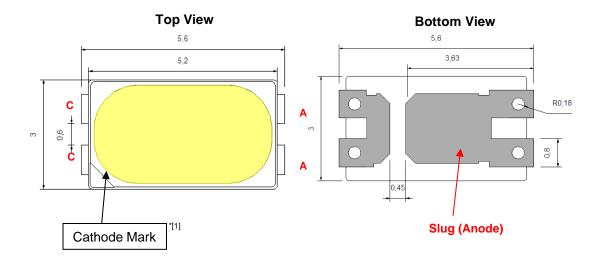
Color Bin Structure

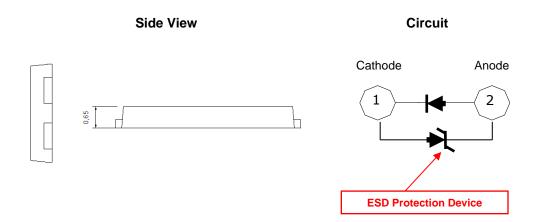
CIE Chromaticity Diagram (Warm white), T_j=25 °C, I_F=32mA



H11		H21		H31		H41	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4562	0.4260	0.4625	0.4275	0.4687	0.4289	0.4750	0.4304
0.4515	0.4168	0.4575	0.4182	0.4636	0.4197	0.4697	0.4211
0.4575	0.4182	0.4636	0.4197	0.4697	0.4211	0.4758	0.4225
0.4625	0.4275	0.4687	0.4289	0.4750	0.4304	0.4810	0.4319
H12		H22		H32		H42	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4515	0.4168	0.4575	0.4182	0.4636	0.4197	0.4697	0.4211
0.4468	0.4077	0.4526	0.4090	0.4585	0.4104	0.4644	0.4118
0.4526	0.4090	0.4585	0.4104	0.4644	0.4118	0.4703	0.4132
0.4575	0.4182	0.4636	0.4197	0.4697	0.4211	0.4758	0.4225
H13		H23		H33		H43	
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.4468	CIE Y 0.4077	CIE X 0.4526	CIE Y 0.4090	CIE X 0.4585	CIE Y 0.4104	CIE X 0.4644	CIE Y 0.4118
0.4468	0.4077	0.4526	0.4090	0.4585	0.4104	0.4644	0.4118
0.4468 0.4420	0.4077 0.3985	0.4526 0.4477	0.4090 0.3998	0.4585 0.4534	0.4104 0.4012	0.4644 0.4591	0.4118 0.4025
0.4468 0.4420 0.4477	0.4077 0.3985 0.3998 0.4090	0.4526 0.4477 0.4534 0.4585	0.4090 0.3998 0.4012	0.4585 0.4534 0.4591	0.4104 0.4012 0.4025 0.4118	0.4644 0.4591 0.4648	0.4118 0.4025 0.4038 0.4132
0.4468 0.4420 0.4477 0.4526	0.4077 0.3985 0.3998 0.4090	0.4526 0.4477 0.4534 0.4585	0.4090 0.3998 0.4012 0.4104	0.4585 0.4534 0.4591 0.4644	0.4104 0.4012 0.4025 0.4118	0.4644 0.4591 0.4648 0.4703	0.4118 0.4025 0.4038 0.4132
0.4468 0.4420 0.4477 0.4526	0.4077 0.3985 0.3998 0.4090	0.4526 0.4477 0.4534 0.4585	0.4090 0.3998 0.4012 0.4104	0.4585 0.4534 0.4591 0.4644	0.4104 0.4012 0.4025 0.4118	0.4644 0.4591 0.4648 0.4703	0.4118 0.4025 0.4038 0.4132
0.4468 0.4420 0.4477 0.4526 H ²	0.4077 0.3985 0.3998 0.4090	0.4526 0.4477 0.4534 0.4585 H:	0.4090 0.3998 0.4012 0.4104 CIE Y	0.4585 0.4534 0.4591 0.4644 HS	0.4104 0.4012 0.4025 0.4118 34 CIE Y	0.4644 0.4591 0.4648 0.4703 HA	0.4118 0.4025 0.4038 0.4132 44 CIE Y
0.4468 0.4420 0.4477 0.4526 H' CIE X 0.4420	0.4077 0.3985 0.3998 0.4090 14 CIE Y 0.3985	0.4526 0.4477 0.4534 0.4585 H: CIE X 0.4477	0.4090 0.3998 0.4012 0.4104 24 CIE Y 0.3998	0.4585 0.4534 0.4591 0.4644 H3 CIE X 0.4534	0.4104 0.4012 0.4025 0.4118 64 CIE Y 0.4012	0.4644 0.4591 0.4648 0.4703 H4 CIE X 0.4591	0.4118 0.4025 0.4038 0.4132 44 CIE Y 0.4025

Mechanical Dimensions





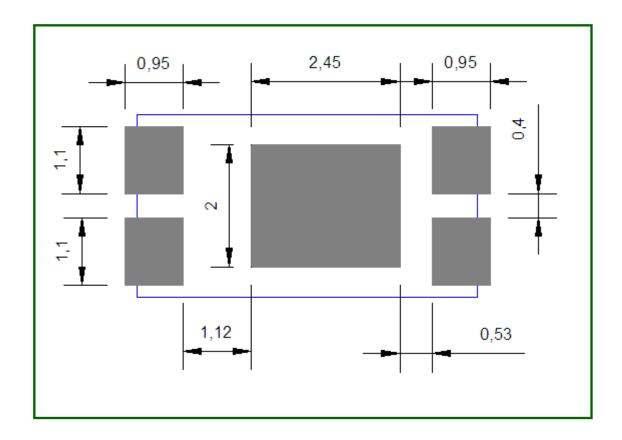
Notes:

(1) All dimensions are in millimeters.

(2) Scale: none

(3) Undefined tolerance is $\pm 0.2 mm$

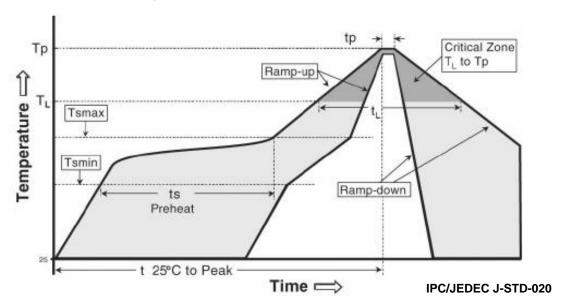
Recommended Solder Pad



Notes:

- (1) All dimensions are in millimeters.
- (2) Scale: none
- (3) This drawing without tolerances are for reference only
- (4) Undefined tolerance is ± 0.1 mm
- (5) The appearance and specifications of the product may be changed for improvement without notice.

Reflow Soldering Characteristics

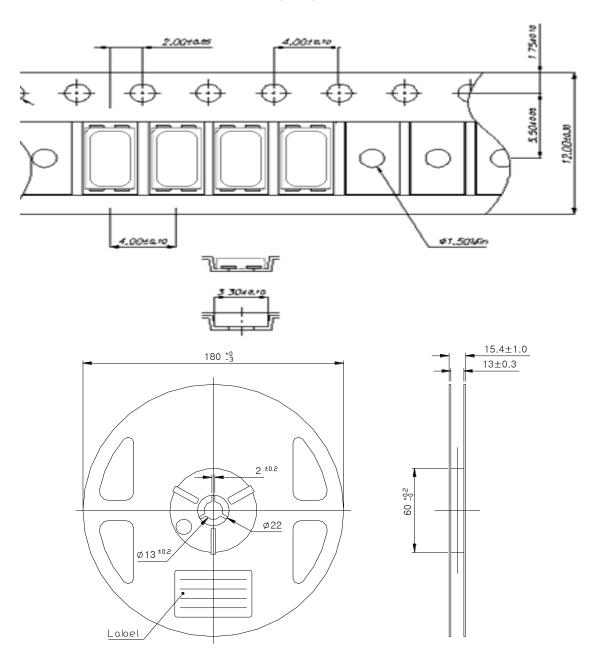


Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (T _{s_max} to T _p)	3° C/second max.	3° C/second max.
$ \begin{array}{c} \textbf{Preheat} \\ \textbf{- Temperature Min } (\textbf{T}_{\text{S_min}}) \\ \textbf{- Temperature Max } (\textbf{T}_{\text{S_max}}) \\ \textbf{- Time } (\textbf{T}_{\text{S_min}} \ \text{to } \textbf{T}_{\text{S_max}}) \ (\textbf{t}_{\text{S}}) \\ \end{array} $	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds
Time maintained above: - Temperature (T _L) - Time (t _L)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (T _p)	215℃	260℃
Time within 5°C of actual Peak Temperature (t _p)2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Caution:

- (1) Reflow soldering is recommended not to be done more than two times
 In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.

Emitter Tape & Reel Packaging



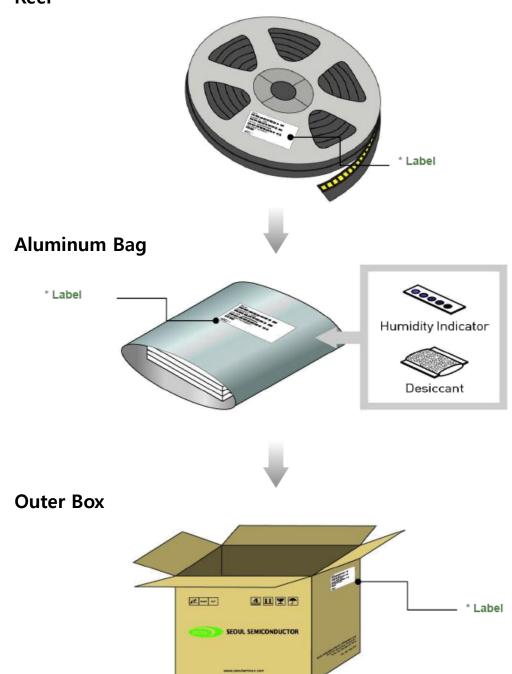
(Tolerance: ± 0.2 , Unit: mm)

Notes:

- (1) Quantity: Max 4,500pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ± 0.2 mm
- (3) Adhesion Strength of Cover Tape
 Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.
- (4) Package: P/N, Manufacturing data Code No. and Quantity to be indicated on a damp proof Package.

Emitter Tape & Reel Packaging

Reel

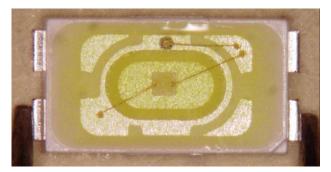


Handling of Silicone Resin for LEDs

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



(2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.



- (3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.
- (4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust.

As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.

- (5) SSC suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin.

 Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.
- (6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this. product with acid or sulfur material in sealed space.

Precaution for Use

(1) Storage

To avoid the moisture penetration, we recommend store in a dry box with a desiccant.

The recommended storage temperature range is 5 $^{\circ}$ C to 30 $^{\circ}$ C and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging

Use proper SMT techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Recommend conditions after opening the package
 - Sealing
 - Temperature : 5 ~ 30 °C Humidity : less than RH60%
- b. If the package has been opened more than 4 week(MSL_2a) or the color of the desiccant changes, components should be dried for 10-24hr at 65 ± 5 °C
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication.
 These products are dangerous if they are burned or shredded in the process of disposal.
 It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.
- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.

Precaution for Use

- (10) The appearance and specifications of the product may be modified for improvement without notice.
- (11) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- (12) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture. Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.
- (13) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (14) The driving circuit must be designed to allow forward voltage only when it is ON or OFF.
 If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.
- (15) Similar to most Solid state devices;
 LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS).
 Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.
- a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following recommendations are suggested to help minimize the potential for an ESD event. One or more recommended work area suggestions:

- Ionizing fan setup
- ESD table/shelf mat made of conductive materials
- ESD safe storage containers

One or more personnel suggestion options:

- Antistatic wrist-strap
- Antistatic material shoes
- Antistatic clothes

Environmental controls:

- Humidity control (ESD gets worse in a dry environment)



Precaution for Use

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device. The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package
 (If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)
- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power

Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures. It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred:

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
- This damage usually appears due to the thermal stress produced during the EOS event.
- c. To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:
 - A surge protection circuit
 - An appropriately rated over voltage protection device
 - A current limiting device



Company Information

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Company Information

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

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